

# MC10E107

## 5 V ECL Quint 2-Input XOR/XNOR Gate

### Description

The MC10E107 is a quint 2-input XOR/XNOR gate. The function output F is the OR of all five XOR outputs, while  $\bar{F}$  is the NOR. The Q outputs need not be terminated if only the F outputs are to be used.

The 100 Series contains temperature compensation.

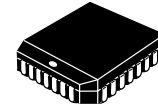
### Features

- 600 ps Maximum Propagation Delay
- OR/NOR Function Outputs
- PECL Mode Operating Range:
  - ◆  $V_{CC} = 4.2\text{ V to }5.7\text{ V}$  with  $V_{EE} = 0\text{ V}$
- NECL Mode Operating Range:
  - ◆  $V_{CC} = 0\text{ V}$  with  $V_{EE} = -4.2\text{ V to }-5.7\text{ V}$
- Internal Input 50 k $\Omega$  Pulldown Resistors
- ESD Protection:
  - ◆ Human Body Model; > 2 kV
  - ◆ Machine Model; > 200 V
- Meets or Exceeds JEDEC Standard EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 3 (Pb-Free)
  - ◆ For Additional Information, see Application Note [AND8003/D](#)
- Flammability Rating:
  - ◆ UL 94 V-0 @ 0.125 in, Oxygen Index: 28 to 34
- Transistor Count = 140 devices
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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PLCC-28  
FN SUFFIX  
CASE 776-02

### MARKING DIAGRAM\*



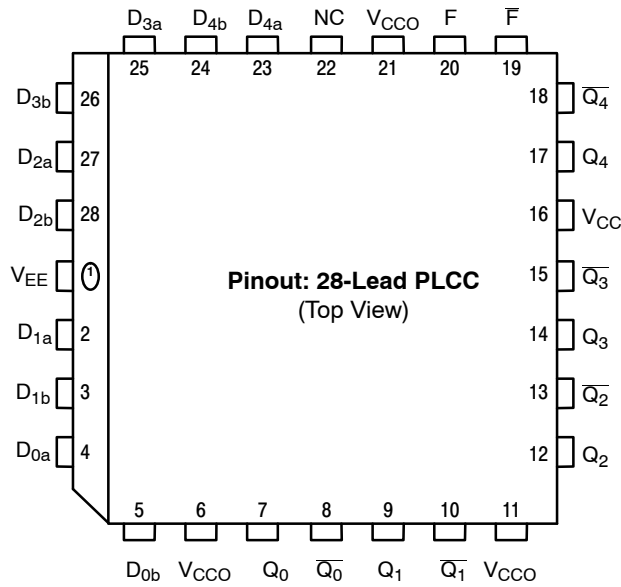
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

\*For additional marking information, refer to Application Note [AND8002/D](#).

### ORDERING INFORMATION

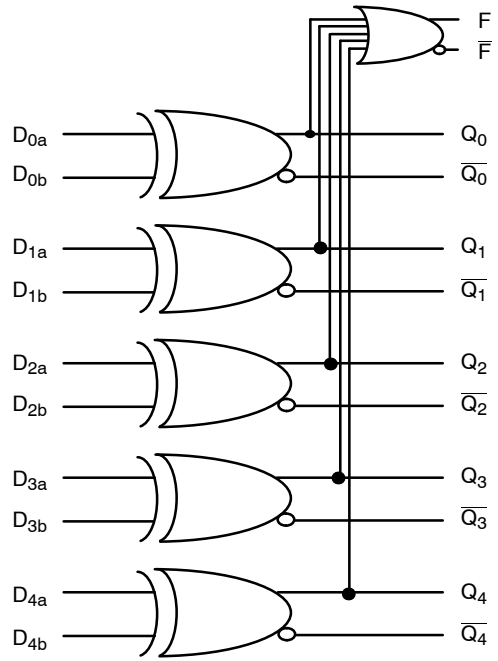
Device	Package	Shipping
MC10E107FNG	PLCC-28 (Pb-Free)	37 Units/Tube

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D0b VCCO Q0 Q0-bar Q1 Q1-bar VCCO  
 All VCC and VCCO pins are tied together on the die.  
 Warning: All VCC, VCCO, and VEE pins must be externally connected to Power Supply to guarantee proper operation.

**Figure 1. 28-Lead Pinout (Top View)**



**Figure 2. Logic Diagram**

**Table 1. PIN DESCRIPTION**

PIN	FUNCTION
D0a - D4b	ECL Data Inputs
Q0 - Q4	ECL XOR Outputs
Q0-bar - Q4-bar	ECL XNOR Outputs
F	ECL OR Output
F-bar	ECL NOR Output
VCC, VCCO	Positive Supply
VEE	Negative Supply
NC	No Connect

**Table 2. FUNCTION OUTPUTS**

$$F = (D_{0a} \oplus D_{0b}) + (D_{1a} \oplus D_{1b}) (D_{2a} \oplus D_{2b}) + (D_{3a} \oplus D_{3b}) + (D_{4a} \oplus D_{4b})$$

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**Table 3. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		8	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
V <sub>I</sub>	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	V <sub>I</sub> ≤ V <sub>CC</sub> V <sub>I</sub> ≥ V <sub>EE</sub>	6 -6	V
I <sub>out</sub>	Output Current	Continuous Surge		50 100	mA
T <sub>A</sub>	Operating Temperature Range			0 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
θ <sub>JA</sub>	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	PLCC-28	63.5 43.5	°C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	Standard Board	PLCC-28	22 to 26	°C/W
T <sub>sol</sub>	Wave Solder (Pb-Free)			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Table 4. 10E SERIES PECL DC CHARACTERISTICS** (V<sub>CC</sub> = 5.0 V, V<sub>EE</sub> = 0.0 V (Note 1))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>EE</sub>	Power Supply Current		42	50		42	50		42	50	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	3980	4070	4160	4020	4105	4190	4090	4185	4280	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	3050	3210	3370	3050	3210	3370	3050	3227	3405	mV
V <sub>IH</sub>	Input HIGH Voltage	3830	3995	4160	3870	4030	4190	3940	4110	4280	mV
V <sub>IL</sub>	Input LOW Voltage	3050	3285	3520	3050	3285	3520	3050	3302	3555	mV
I <sub>IH</sub>	Input HIGH Current			200			200			200	μA
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.25		0.3	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary -0.46 V / +0.06 V.
2. Outputs are terminated through a 50 Ω resistor to V<sub>CC</sub> - 2.0 V.

**Table 5. 10E SERIES NECL DC CHARACTERISTICS** (V<sub>CCx</sub> = 0.0 V; V<sub>EE</sub> = -5.0 V (Note 1))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>EE</sub>	Power Supply Current		42	50		42	50		42	50	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	-1020	-930	-840	-980	-895	-810	-910	-815	-720	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	-1950	-1790	-1630	-1950	-1790	-1630	-1950	-1773	-1595	mV
V <sub>IH</sub>	Input HIGH Voltage	-1170	-1005	-840	-1130	-970	-810	-1060	-890	-720	mV
V <sub>IL</sub>	Input LOW Voltage	-1950	-1715	-1480	-1950	-1715	-1480	-1950	-1698	-1445	mV
I <sub>IH</sub>	Input HIGH Current			200			200			200	μA
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.065		0.3	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary -0.46 V / +0.06 V.
2. Outputs are terminated through a 50 Ω resistor to V<sub>CC</sub> - 2.0 V.

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**Table 6. 100E SERIES PECL DC CHARACTERISTICS** ( $V_{CCx} = 5.0\text{ V}$ ;  $V_{EE} = 0.0\text{ V}$  (Note 1))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		42	50		42	50		48	58	mA
$V_{OH}$	Output HIGH Voltage (Note 2)	3975	4050	4120	3975	4050	4120	3975	4050	4120	mV
$V_{OL}$	Output LOW Voltage (Note 2)	3190	3295	3380	3190	3255	3380	3190	3260	3380	mV
$V_{IH}$	Input HIGH Voltage	3835	3975	4120	3835	3975	4120	3835	3975	4120	mV
$V_{IL}$	Input LOW Voltage	3190	3355	3525	3190	3355	3525	3190	3355	3525	mV
$I_{IH}$	Input HIGH Current			200			200			200	$\mu\text{A}$
$I_{IL}$	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary  $-0.46\text{ V} / +0.8\text{ V}$ .
2. Outputs are terminated through a  $50\ \Omega$  resistor to  $V_{CC} - 2.0\text{ V}$ .

**Table 7. 100E SERIES NECL DC CHARACTERISTICS** ( $V_{CCx} = 0\text{ V}$ ;  $V_{EE} = -5.0\text{ V}$  (Note 1))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		42	50		42	50		48	58	mA
$V_{OH}$	Output HIGH Voltage (Note 2)	-1025	-950	-880	-1025	-950	-880	-1025	-950	-880	mV
$V_{OL}$	Output LOW Voltage (Note 2)	-1810	-1705	-1620	-1810	-1745	-1620	-1810	-1740	-1620	mV
$V_{IH}$	Input HIGH Voltage	-1165	-1025	-880	-1165	-1025	-880	-1165	-1025	-880	mV
$V_{IL}$	Input LOW Voltage	-1810	-1645	-1475	-1810	-1645	-1475	-1810	-1645	-1475	mV
$I_{IH}$	Input HIGH Current			200			200			200	$\mu\text{A}$
$I_{IL}$	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary  $-0.46\text{ V} / +0.8\text{ V}$ .
2. Outputs are terminated through a  $50\ \Omega$  resistor to  $V_{CC} - 2.0\text{ V}$ .

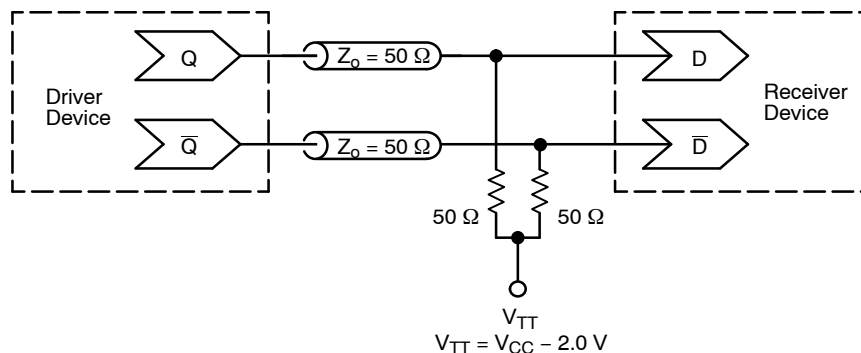
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**Table 8. AC CHARACTERISTICS** ( $V_{CCx} = 5.0\text{ V}$ ;  $V_{EE} = 0.0\text{ V}$  or  $V_{CCx} = 0.0\text{ V}$ ;  $V_{EE} = -5.0\text{ V}$  (Note 1))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{MAX}$	Maximum Toggle Frequency		700			700			700		MHz
$t_{PLH}$ $t_{PHL}$	Propagation Delay to Output D to Q D to F	250 500	410 725	600 1000	250 500	410 725	600 1000	250 500	410 725	600 1000	ps
$t_{SKEW}$	Within-Device Skew (Note 2) D to Q		75			75			75		ps
$t_{JITTER}$	Random Clock Jitter (RMS)		< 1			< 1			< 1		ps
$t_r$ $t_f$	Rise/Fall Time (20 - 80%) Q F	275 300	450 475	700 700	275 300	450 475	700 700	275 300	450 475	700 700	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 10 Series:  $V_{EE}$  can vary  $-0.46\text{ V} / +0.06\text{ V}$ .  
100 Series:  $V_{EE}$  can vary  $-0.46\text{ V} / +0.8\text{ V}$ .
- Within-device skew is defined as identical transitions on similar paths through a device.



**Figure 3. Typical Termination for Output Driver and Device Evaluation**  
(See Application Note [AND8020/D](#) – Termination of ECL Logic Devices.)

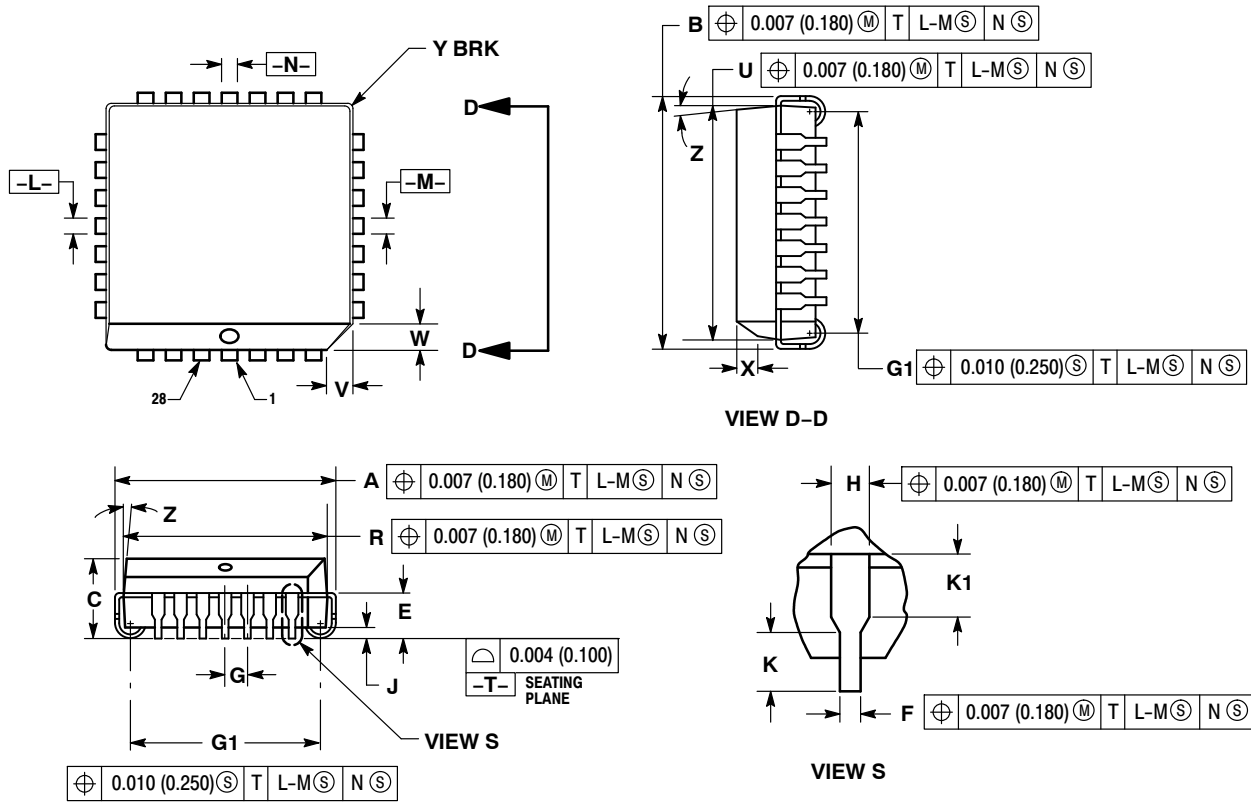
### Resource Reference of Application Notes

- AN1405/D** – ECL Clock Distribution Techniques
- AN1406/D** – Designing with PECL (ECL at +5.0 V)
- AN1503/D** – ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** – Metastability and the ECLinPS Family
- AN1568/D** – Interfacing Between LVDS and ECL
- AN1642/D** – The ECL Translator Guide
- AND8001/D** – Odd Number Counters Design
- AND8002/D** – Marking and Date Codes
- AND8020/D** – Termination of ECL Logic Devices
- AND8066/D** – Interfacing with ECLinPS
- AND8090/D** – AC Characteristics of ECL Devices

# MC10E107

## PACKAGE DIMENSIONS

28 LEAD PLLC  
CASE 776-02  
ISSUE F




### NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION  $G1$ , TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE BOTTOM MAY BE SMALLER THAN THE PACKAGE TOP BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.021	0.33	0.53
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°		10°	
G1	0.410	0.430	10.42	10.92
K1	0.040	---	1.02	---

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